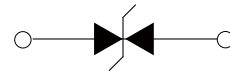


## FEATURES

- | Low profile package
- | Ideal for automated placement
- | 400 Watt peak pulse power capability with a 10/1000µs waveform
- | For surface mounted applications to optimize board space
- | Excellent clamping capability
- | Very fast response time
- | Low incremental surge resistance



DO-214AC(SMA)



Schematic Symbol

## APPLICATIONS

- | Power supply protection
- | Automotive application
- | Industrial application
- | Power management

## APPROVALS

<b>RoHS</b>	Compliance with 2011/65/EU
<b>HF</b>	Compliance with IEC61249-2-21:2003

## MAXIMUM RATINGS (T<sub>A</sub> = 25°C )

Parameter	Symbol	Value	Unit
Peak Pulse Power Dissipation on 10/1000us waveform (Note1, Note2).	P <sub>PPM</sub>	400	Watts
Peak Pulse Current of on 10/1000us waveform (Note1)	I <sub>PPM</sub>	See Table	Amps
Steady State Power Dissipation at T <sub>L</sub> =75°C, Lead lengths.375" (9.5mm) ( Note2)	P <sub>M(AV)</sub>	3.3	Watts

- Notes :** 1.Non-repetitive current pulse, T<sub>A</sub> = 25°C.  
 2.Mounted on 5.0mm x 5.0mm (0.03mm thick) Copper Pads to each terminal.

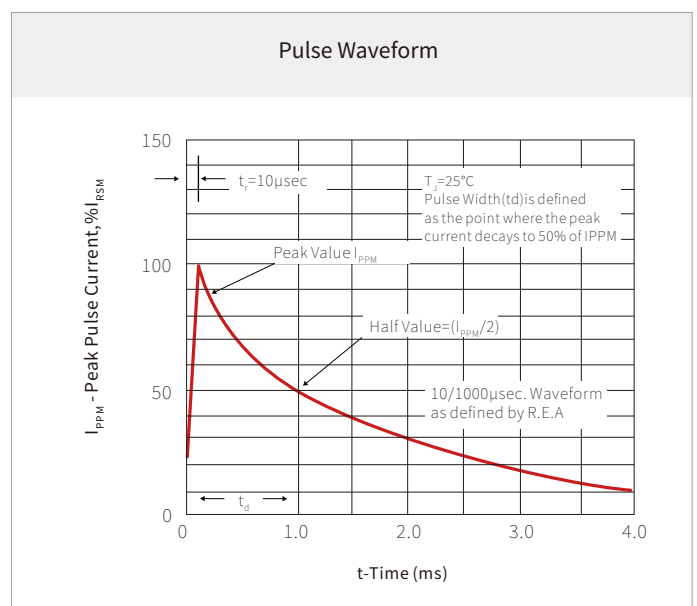
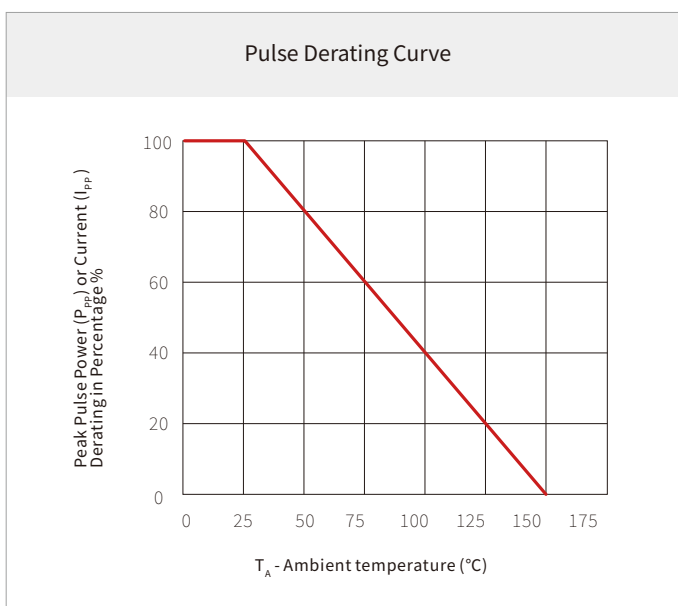
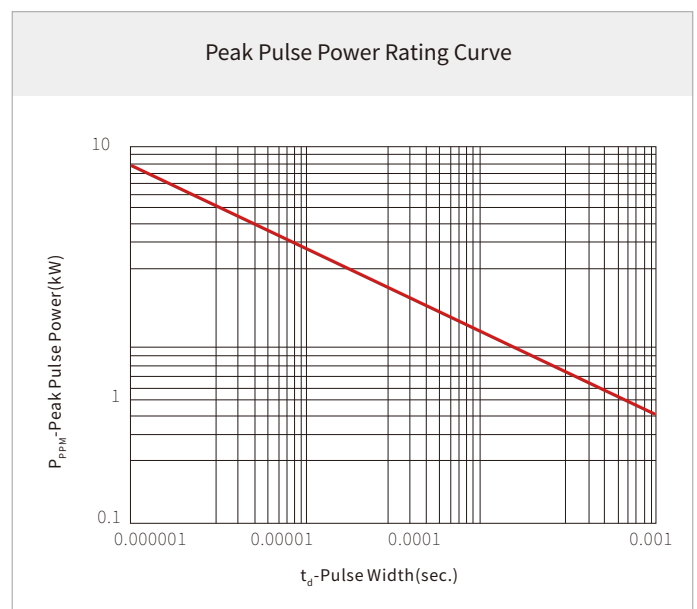
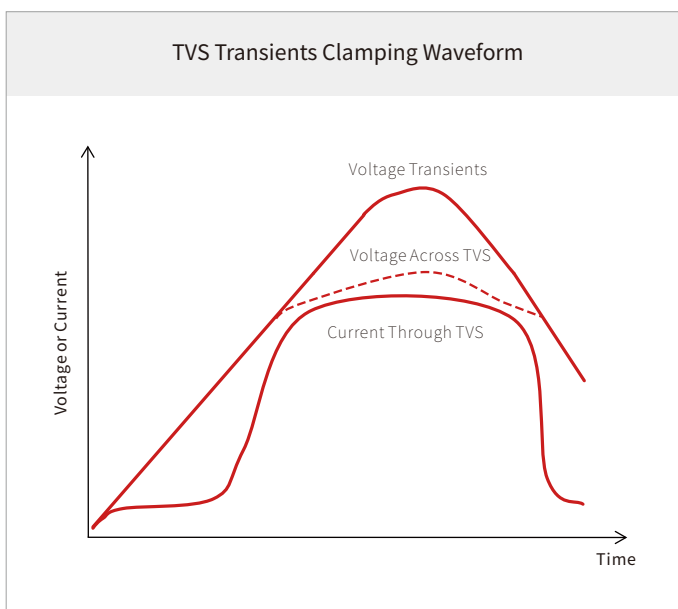
## THERMAL CONSIDERATIONS

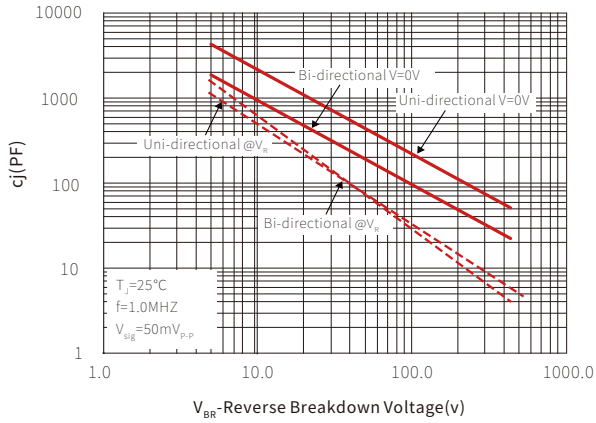
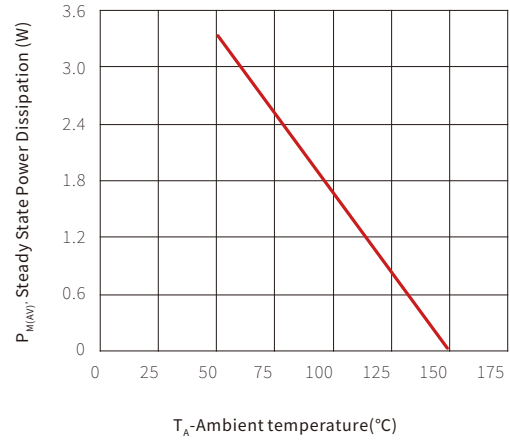
Parameter	Symbol	Value	Unit
Operating Junction Temperature	T <sub>J</sub>	-55 to +150	°C
Storage Temperature Range	T <sub>STG</sub>	-55 to +150	°C
Junction to Ambient on printed circuit	R <sub>θJA</sub>	120	°C/W

## ELECTRICAL CHARACTERISTICS (T<sub>A</sub>=25°C)

Part Number	Device Marking Code	Reverse Stand-off Voltage	Breakdown Voltage Min.@I <sub>T</sub>	Breakdown Voltage Max.@I <sub>T</sub>	Test Current	Maximum Clamping Voltage @I <sub>PP</sub>	Peak Pulse Current	Reverse Leakage @V <sub>RWM</sub>
		V <sub>RWM</sub> (V)	V <sub>BR</sub> (V)	V <sub>BR</sub> (V)	I <sub>T</sub> (mA)	V <sub>C</sub> (V)	I <sub>PP</sub> (A)	I <sub>R</sub> (uA)
SVA40B51	YZ	51.0	56.7	62.7	1.0	82.4	4.9	1.0

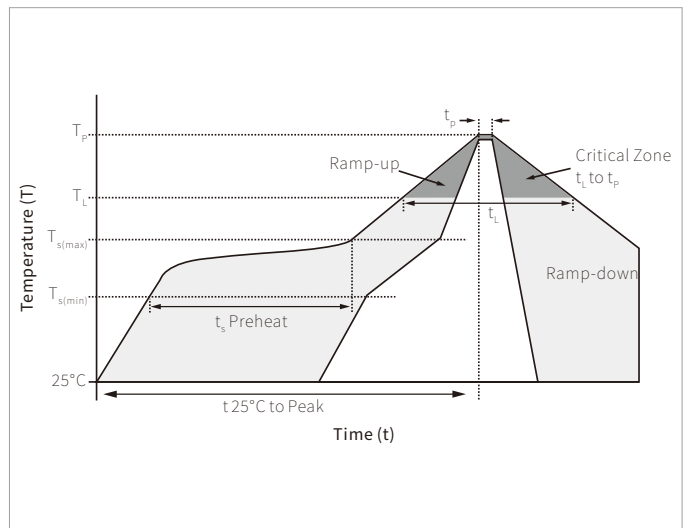
## CHARACTERISTIC CURVES



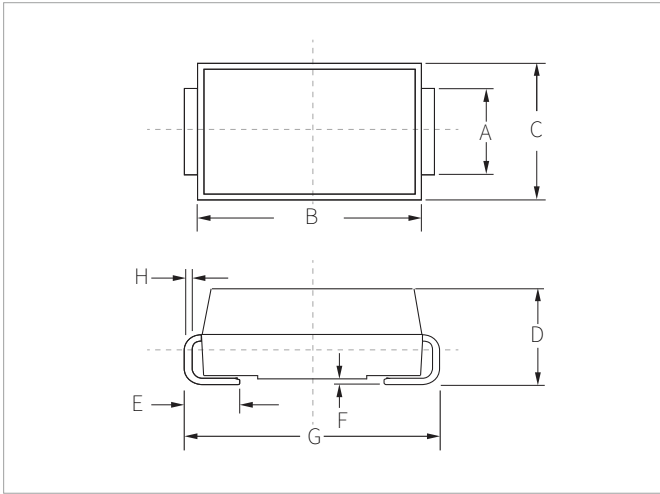
**Typical Junction Capacitance**

**Steady State Power Dissipation Derating Curve**


## SOLDERING PARAMETERS

Reflow Condition		Lead-free assembly
Pre Heat	Temperature Max ( $T_{s(min)}$ )	150°C
	Temperature Max ( $T_{s(max)}$ )	200°C
	Time (min to max) ( $t_s$ )	60 – 180 secs
Average ramp up rate (Liquidus Temp ( $T_L$ ) to peak $T_{s(max)}$ ) to $T_L$ - Ramp-up Rate		3°C/second max
Reflow	Temperature ( $T_r$ ) (Liquidus)	217°C
	Time (min to max) ( $t_r$ )	60 – 150 seconds
Peak Temperature ( $T_p$ )		260°C
Time within 5°C of actual peak Temperature ( $t_p$ )		20 – 40 seconds
Ramp-down Rate		6°C/second max
Time 25°C to peak Temperature ( $T_p$ )		8 minutes max.
Do not exceed		260°C

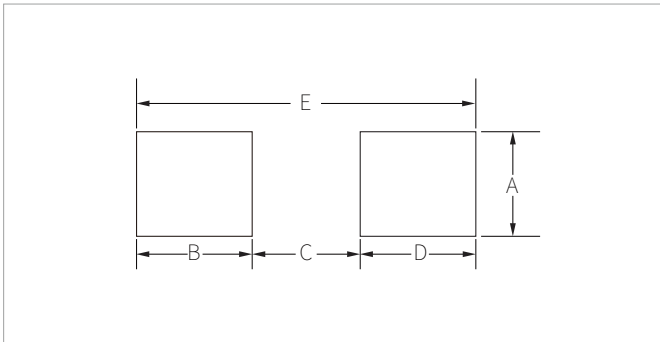


## DO-214AC(SMA) PACKAGE INFORMATION



Ref.	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	1.20	1.60	0.047	0.063
B	4.20	4.60	0.165	0.181
C	2.60	2.80	0.102	0.110
D	2.10	2.40	0.083	0.094
E	0.76	1.52	0.030	0.060
F	0.02	0.20	0.001	0.008
G	4.85	5.25	0.191	0.207
H	0.15	0.30	0.006	0.012

## RECOMMENDED PAD LAYOUT DIMENSIONS



Ref.	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	1.63	-	0.064	-
B	1.45	-	0.057	-
C	-	2.80	-	0.090
D	1.45	-	0.057	-
E	5.28REF		0.208REF	

## ORDERING INFORMATION

Part Number	Component Package	QTY/Reel	Reel Size
SVA40B51	DO-214AC(SMA)	5000PCS	13"

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